

# TN1625 TYN616, TYN816

## 16 A standard SCRs

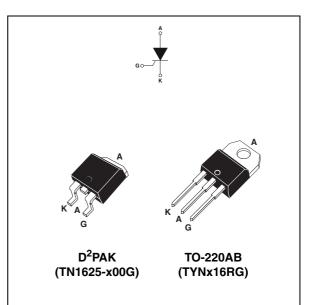
### Features

- I<sub>T(RMS)</sub> =16 A
- $V_{DRM}/V_{RRM} = 600 \text{ to } 1000 \text{ V}$
- I<sub>GT</sub> = 25 mA

## Description

The standard TN16 / TYNx16 16 A SCRs series is suitable for general purpose applications.

Using clip assembly technology, they provide a superior performance in surge current capabilities.



### Table 1.Device summary

Parameter	TN1625-600G TYN616RG	TYN816RG	TN1625-1000G	Unit
V <sub>DRM</sub> /V <sub>RRM</sub>	600	800	1000	V
Sensitivity	25	25	25	mA

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# 1 Characteristics

Symbol	Parameter	Value	Unit		
I <sub>T(RMS)</sub>	RMS on-state current (180 °Conduction angle	16	А		
I <sub>T(AV)</sub>	Average on-state current (180 °Conduction an	igle)	T <sub>c</sub> = 110 °C	10	А
	Non repetitive surge peak on-state current $\frac{t_p = 8.3 \text{ ms}}{T_i = 25 \text{ °C}}$		$t_p = 8.3 \text{ ms}$ 200	200	А
I <sub>TSM</sub> Non repetitive surge peak on-state cu		t <sub>p</sub> = 10 ms	$-1_j = 25$ C	190	A
l <sup>2</sup> t	$I^2t$ Value for fusing $t_p = 10 \text{ ms}$		T <sub>j</sub> = 25 °C	180	A <sup>2</sup> s
dl/dt	$ \begin{array}{l} \mbox{Critical rate of rise of on-state current} \\ I_G = 2 \ x \ I_{GT} \ , \ t_r \leq 100 \ ns \end{array} \end{array} \ F = 60 \ Hz $		T <sub>j</sub> = 125 °C	50	A/µs
I <sub>GM</sub>	Peak gate current	4	А		
P <sub>G(AV)</sub>	Average gate power dissipation	1	W		
T <sub>stg</sub> T <sub>j</sub>	Storage junction temperature range Operating junction temperature range	- 40 to + 150 - 40 to + 125	°C		
V <sub>RGM</sub>	Maximum peak reverse gate voltage	5	V		

### Table 2. Absolute ratings (limiting values)

### Table 3. Electrical characteristics (T<sub>i</sub> = 25 °C, unless otherwise specified)

Symbol	Test Conditions		Value	Unit	
			MIN.	2	mA
I <sub>GT</sub>	$V_D = 12 V$ $R_L = 33 \Omega$		MAX.	25	
V <sub>GT</sub>			MAX.	1.3	V
V <sub>GD</sub>	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$	T <sub>j</sub> = 125 °C	MIN.	0.2	V
Ι <sub>Η</sub>	I <sub>T</sub> = 500 mA Gate open	MAX.	40	mA	
١L	$I_{G} = 1.2 \text{ x } I_{GT}$		MAX.	60	mA
dV/dt	V <sub>D</sub> = 67 % V <sub>DRM</sub> Gate open	T <sub>j</sub> = 125 °C	MIN.	500	V/µs
V <sub>TM</sub>	$I_{TM} = 32 \text{ A}  t_p = 380 \ \mu \text{s}$ $T_j = 25 \ ^\circ \text{C}$		MAX.	1.6	V
V <sub>t0</sub>	Threshold voltage	T <sub>j</sub> = 125 °C	MAX.	0.77	V
R <sub>d</sub>	Dynamic resistance	T <sub>j</sub> = 125 °C	MAX.	23	mΩ
I <sub>DRM</sub>	V	T <sub>j</sub> = 25 °C	MAX.	5	μA
I <sub>RRM</sub>	V <sub>DRM</sub> = V <sub>RRM</sub>	T <sub>j</sub> = 125 °C		2	mA

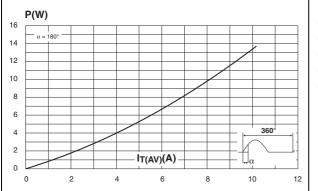
### Table 4. Thermal resistance

Symbol	Parameter			Value	Unit
R <sub>th(j-c)</sub>	Junction to case (DC)			1.1	°C/W
D	Junction to ambient (DC)	$S = 01 \text{ cm}^2$	D <sup>2</sup> PAK	45	°C/W
R <sub>th(j-a)</sub>			TO-220AB	60	C/W

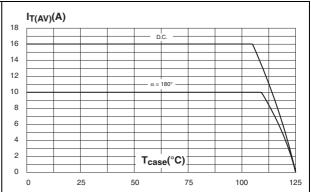
S = copper surface under tab

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### Figure 1. Maximum average power dissipation versus average on-state current



# Figure 2. Average and D.C. on-state current versus case temperature



### Figure 3. Average and D.C. on-state current Figure 4. versus ambient temperature (copper surface under tab: S=1cm<sup>2</sup>) (D<sup>2</sup>PAK)

Relative variation of thermal impedance versus pulse duration

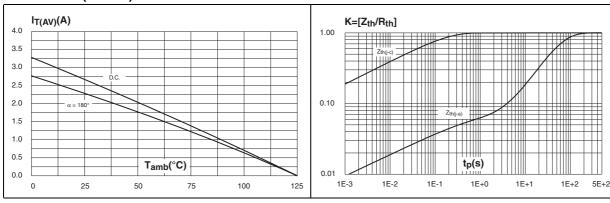
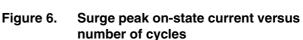
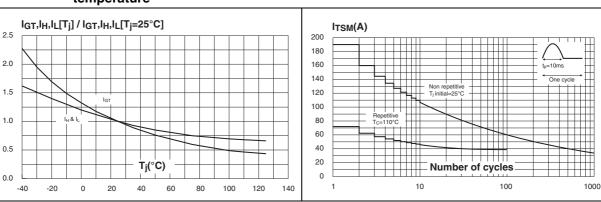


Figure 5. Relative variation of gate trigger current, holding current and latching current versus junction temperature





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# Figure 7. Non-repetitive surge peak on-state Figure 8. current for a sinusoidal pulse with width $t_p < 10$ ms, and corresponding values of $l^2t$

# 3. On-state characteristics (maximum values)

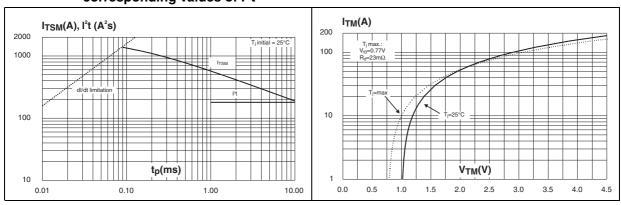
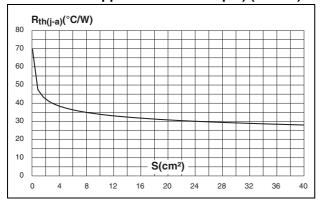


Figure 9. Thermal resistance junction to ambient versus copper surface under tab (epoxy printed circuit board FR4, copper thickness: 35 μm) (D<sup>2</sup>PAK)



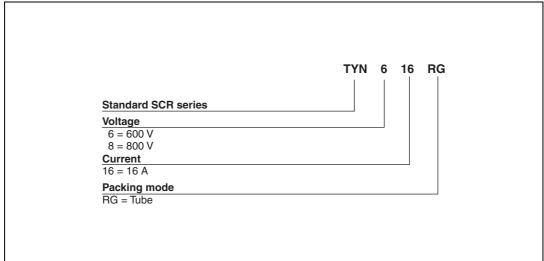


# 2 Ordering information scheme

### Figure 10. TN1625

Standard SCR series	
Current 16 = 16 A	
Sensitivity 25 = 25 mA	
Voltage 600 = 600 V 1000 = 1000 V	
Package G = D <sup>2</sup> PAK	
Packing mode Blank = Tube -TR = Tape and reel	

### Figure 11. TYNx16





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## 3 Package information

- Epoxy meets UL94,V0
- Cooling method: C
- Recommended torque value: 0.4 0.6 N·m

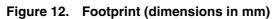
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

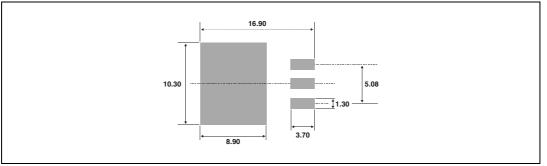
Table 5. TO-220AB dimensions

					Dimer	nsions		
		Ref.	M	illimete	rs		Inches	
			Min.	Тур.	Max.	Min.	Тур.	Max.
		А	15.20		15.90	0.598		0.625
		a1		3.75			0.147	
Ø I	C L	a2	13.00		14.00	0.511		0.551
	<u>b2</u> ,	В	10.00		10.40	0.393		0.409
	F	b1	0.61		0.88	0.024		0.034
A		b2	1.23		1.32	0.048		0.051
14 I3 ·		С	4.40		4.60	0.173		0.181
	c2	c1	0.49		0.70	0.019		0.027
		c2	2.40		2.72	0.094		0.107
a2		е	2.40		2.70	0.094		0.106
	M ↔ c1	F	6.20		6.60	0.244		0.259
e → tite b1	←→ <u>c1</u>	ØI	3.75		3.85	0.147		0.151
		14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116
		12	1.14		1.70	0.044		0.066
		13	1.14		1.70	0.044		0.066
		М		2.60			0.102	

Table 6. D-PAK d	mensions		-					
					Dimer	nsions		
		Ref.	Mi	illimete	ers	Inches		
			Min.	Тур.	Max.	Min.	Тур.	Max.
		Α	4.30		4.60	0.169		0.181
<u>           </u> F	<u>← A</u> →	A1	2.49		2.69	0.098		0.106
		A2	0.03		0.23	0.001		0.009
		В	0.70		0.93	0.027		0.037
		B2	1.25	1.40		0.048	0.055	
		С	0.45		0.60	0.017		0.024
		C2	1.21		1.36	0.047		0.054
$\rightarrow$		D	8.95		9.35	0.352		0.368
G		Е	10.00		10.28	0.393		0.405
	2mm min.	G	4.88		5.28	0.192		0.208
	FLAT ZONE	L	15.00		15.85	0.590		0.624
	V2	L2	1.27		1.40	0.050		0.055
		L3	1.40		1.75	0.055		0.069
		R		0.40			0.016	
		V2	0°		8°	0°		8°

Table 6.D<sup>2</sup>PAK dimensions







# 4 Ordering information

### Table 7.Ordering information

Order code <sup>(1)</sup>	Marking <sup>(1)</sup>	Package	Weight	Base qty	Delivery mode
TN1625-x00G	TN1625x00G	D <sup>2</sup> PAK	1.5 g	50	Tube
TN1625-x00G-TR	TN1625x00G	D <sup>2</sup> PAK	1.5 g	1000	Tape and reel
TYNx16RG	TYNx16	TO-220AB	2.3 g	50	Tube

1. x indicates votage, 6, 8 or 10 for 600, 800 and 1000 V respectively

# 5 Revision history

Table 8.	Document revision history

Date	Revision	Changes
Apr-2002	4A	Last update.
13-Feb-2006	5	TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.
07-Nov-2007	6	Reformatted to current standards. Table 2.: $I_{T(RMS)}$ value corrected from 12 A to 16 A

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